

App. Serial No 10/528,941
GB020162US

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OCT 09 2007

LISTING OF THE CLAIMS

Please amend claims 1-10 as indicated below. This listing of claims replaces all prior versions.

1. (Currently amended) A power semiconductor device, comprising:

first (44) and second (46) main terminals, at least one of which is for coupling a load (52);

a control terminal (48); and

a semiconductor body (2) having opposed first and second major surfaces (14, 16) and a plurality of cells (12) arranged as a lattice across the first major surface (14) of the semiconductor body, the cells (12) being divided into main cells (14) and sense cells (16), each of the cells having a gate or base connected to the control terminal (48)

wherein each of the main cells (14) is connected in parallel between the first and second main terminals (44, 46) to couple the first and second main terminals (44, 46) under the control of the control terminal (48);

the power semiconductor device further comprises first and second sense terminals (40, 42);

the sense cells are divided into a plurality of groups of sense cells (30, 32) each arranged across the lattice in a pattern, each group of sense cells being connected in parallel between a respective sense terminal (40, 42) and the second main terminal (44); and

a first group of sense cells (30) is arranged across the lattice in a pattern having a different ratio of edge to inner cells to a second group of sense cells (32), inner sense cells (34) being cells surrounded by other sense cells of the group and edge sense cells (28) being arranged on the edge of the group of sense cells.

2. (Currently amended) A semiconductor device according to claim 1 wherein the number of edge sense cells (28) in the first and second groups of sense cells (30, 32) is substantially identical.

3. (Currently amended) A semiconductor device according to any preceding claim

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wherein the cells are MOS cells including a gate (8) connected to the control terminal, and a source (10) and drain (2), the source (10) and drain (2) of main cells being connected to the first and second main terminals (44, 46) and the source and drain (10, 2) of sense cells of a group (30, 32) being connected between the second main terminal and the respective sense terminal (40, 42).

4. (Currently amended) A semiconductor device according to claim 3 wherein the cells (12) are trench MOSFET cells.

5. (Currently amended) A semiconductor device according to ~~any of claim~~[[s]] 1 ~~to~~ 4 further comprising a Kelvin terminal connected to the source of the main cells.

6. (Currently amended) A semiconductor arrangement comprising:

a semiconductor device according to ~~any of claim~~[[s]] 1 ~~to~~ 5;

a drive circuit (70) having an input (74) and an output (76), the output (76) being connected to the control terminal (48) for driving the control terminal; and

a compensation circuit (54, 60) having first and second sense inputs (62, 64) connected directly or indirectly to the first and second sense terminals (40, 42), respectively, and an output (66) connected to the drive circuit (70) for controlling the drive circuit, wherein the compensation circuit (54, 60) outputs to the drive circuit input (74) a signal based on the current in inner sense cells (34), obtained from the currents on the first and second sense inputs (40, 42).

7. (Currently amended) A semiconductor arrangement according to claim 6 wherein:

the compensation circuit includes a reference sub-circuit (54) with an input (56) connected to the first sense terminal (40) connected to the first group of sense cells, and an output (58) supplying a reference voltage, wherein the current from the first sense terminal (40) is applied across a resistance (82) to increase the reference voltage linearly with the current from the first group of sense cells;

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the compensation circuit further includes a sense sub-circuit (60) which has an input (62) connected to the second sense terminal (42) connected to the second group of sense cells (32) wherein the current from the second group of sense cells (32) is applied across a like resistance (92) to that in the reference sub-circuit to generate a voltage; and the sense sub-circuit has a compensation input (64) connected to the output (58) of the reference sub-circuit,

the sense sub-circuit being operable to compare the voltage input on the compensation input (64) with that generated across the like resistor (92) to generate an output supplying a compensated sense current signal to the drive circuit input (74) for controlling the drive circuit (70) to limit the current output by the power semiconductor device.

8. (Currently amended) A semiconductor arrangement according to claim 7 wherein:

the power semiconductor device has MOS cells of predetermined first conductivity type having gate (8), source (10) and drain (2), the gates (8) of the cells being connected in parallel to the control terminal (48), the drains (2) of the main and sense cells being connected in common to the first main terminal (44) and the sources of the main (14) and sense (16) cells being connected to the second main terminal (46) and sense terminals (40, 42) respectively;

wherein the second main terminal (46) is connected to a source voltage rail (53) (V_{ss});

the drive circuit (70) includes a FET (96) of the first conductivity type having its source connected to the source voltage rail (53), its drain connected to the control terminal (48) of the power semiconductor device and to a gate drive circuit (98);

the reference sub-circuit (54) includes a FET (80) of the first conductivity type having its source connected to the source voltage rail (53) through the resistance (82), its drain connected through a resistance (84) to a logic supply (68), its gate connected to its drain and to the output (58) of the reference sub-circuit, and wherein the input (56) of the reference sub-circuit is connected to the source of the reference sub-circuit FET (80) for supplying the current output on the first sense terminal (40) to the reference sub-circuit (54); and

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the sense sub-circuit ~~(60)~~ includes a FET ~~(90)~~ of the first conductivity type having its source connected to the source voltage rail ~~(53)~~ through the resistance ~~(92)~~, its drain connected through a resistance ~~(94)~~ to a logic supply ~~(68)~~, its gate connected to the output ~~(58)~~ of the reference sub-circuit, and wherein the input ~~(62)~~ of the sense sub-circuit is connected to the second sense terminal ~~(42)~~ for comparing the current output on the second sense terminal with a value set by the reference sub-circuit and outputting a signal to the drive circuit.

9. (Currently amended) A semiconductor arrangement according to any of claims 6 to 8 housed in a single package ~~(100)~~.

10. (Currently amended) A semiconductor arrangement according to any of claims 6 to 8 [[9]] wherein the first main terminal ~~(44)~~ is connected to a load ~~(52)~~.